Power MOSFET

30 V, 23 A, Single N-Channel, SO₋₈ Flat Lead

Features

- Low R_{DS(on)}
- Low Inductance SO-8 Package
- These are Pb-Free Devices

Applications

- Notebooks, Graphics Cards
- DC-DC Converters
- Synchronous Rectification

MAXIMUM RATINGS (T_J = 25° C unless otherwise noted)

Parameter			Symbol	Value	Unit	
Drain-to-Source Voltage			V _{DSS}	30	V	
Gate-to-Source Voltage			V _{GS}	±20	V	
Continuous Drain Current	Steady	$T_A = 25^{\circ}C$	I _D	14	А	
(Note 1)	State	T _A = 85°C		10		
	$t \le 10 s$	$T_A = 25^{\circ}C$		23		
Power Dissipation (Note 1)	Steady State	T _A = 25°C	P _D	2.2	W	
	$t \le 10 s$			5.8		
Continuous Drain Current	Steady State	$T_A = 25^{\circ}C$	I _D	9.1	А	
(Note 2)		T _A = 85°C		6.5		
Power Dissipation (Note 2)		$T_A = 25^{\circ}C$		0.9	W	
Pulsed Drain Current	t _p =	10 μs	I _{DM}	68	А	
Operating Junction and Storage Temperature			T _J , T _{stg}	–55 to 150	°C	
Source Current (Body Diode)			۱ _S	7.0	А	
Single Pulse Drain-to-Source Avalanche Energy (V _{DD} = 30 V, V _{GS} = 10 V, I _{PK} = 21 A, L = 1 mH, R _G = 25 Ω)			E _{AS}	220	mJ	
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C	

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Ambient - Steady State (Note 1)	$R_{\theta JA}$	56.3	°C/W
Junction-to-Ambient – t \leq 10 s (Note 1)	$R_{\theta JA}$	21.5	
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	141.6	

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Surface mounted on FR4 board using 1 in sq pad size

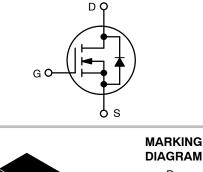
- (Cu area = 1.127 in sq [1 oz] including traces).
- 2. Surface mounted on FR4 board using the minimum recommended pad size (Cu area = 0.0264 in sq).

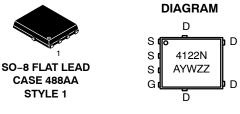


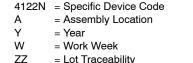
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V _{(BR)DSS}	R _{DS(on)} TYP	I _D MAX (Note 1)
30 V	4.6 mΩ @ 10 V	23 A
30 V	6.3 mΩ @ 4.5 V	23 A







= Lot Traceability

ORDERING INFORMATION

Device	Package	Shipping [†]
NTMFS4122NT1G	SO-8 FL (Pb-Free)	1500 Tape & Reel
NTMFS4122NT3G	SO-8 FL (Pb-Free)	5000 Tape & Reel

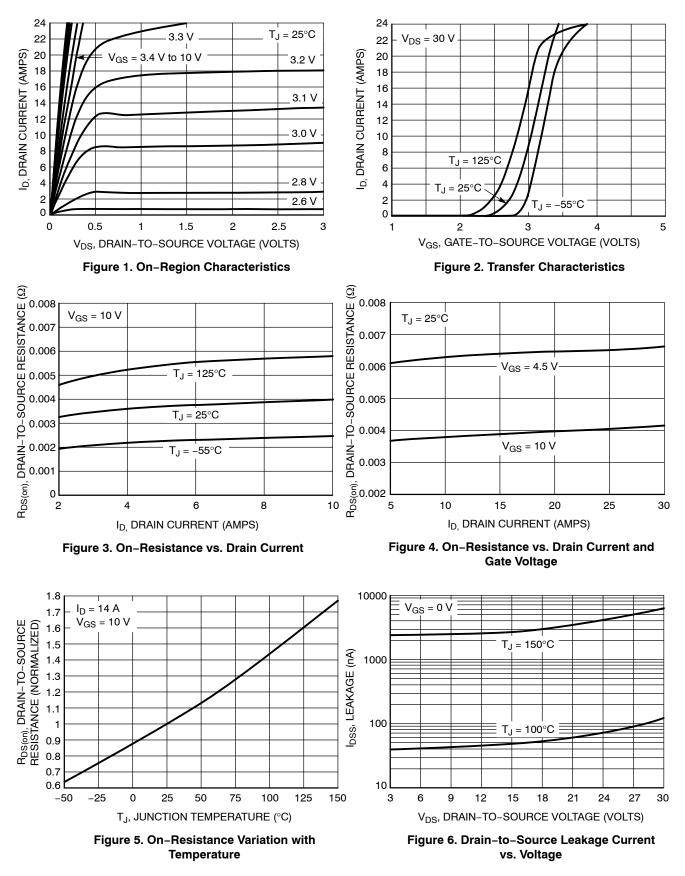
+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS (T_J = $25^{\circ}C$ unless otherwise noted)

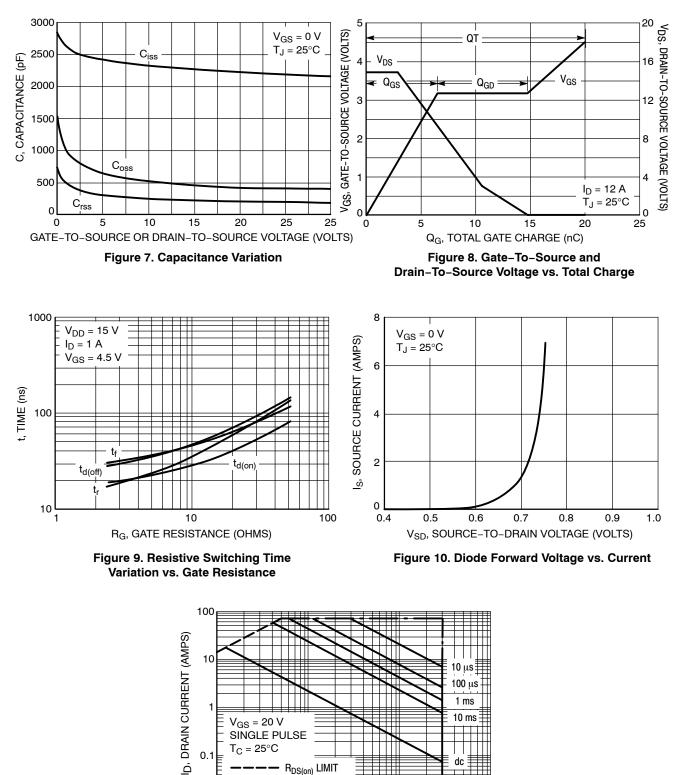
Characteristic	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS	-	•		-	-		-
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V, I _D = 250 μA		30			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J				23		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V_{GS} = 0 V, V_{DS} = 24 V	T _J = 25°C			1.0	μΑ
			T _J = 125°C			10	
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS} =				100	nA
ON CHARACTERISTICS (Note 3)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D = 2$	250 μΑ	1.0		2.5	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J				6.6		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V, I _D = 14 A			4.6	6.0	mΩ
		V _{GS} = 4.5 V, I _D = 12 A			6.3	8.5	1
Forward Transconductance	9 FS	V _{DS} = 15 V, I _D = 10 A			13.2		S
CHARGES, CAPACITANCES AND GATE R	ESISTANCE				•		•
Input Capacitance	C _{ISS}				2310		pF
Output Capacitance	C _{OSS}	V_{GS} = 0 V, f = 1.0 MHz, V_{DS} = 24 V			460		
Reverse Transfer Capacitance	C _{RSS}				263		
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 4.5 V, V _{DS} = 15 V, I _D = 12 A			20	30	nC
Threshold Gate Charge	Q _{G(TH)}				3.0		1
Gate-to-Source Charge	Q _{GS}				6.7		1
Gate-to-Drain Charge	Q _{GD}				8.1		1
Gate Resistance	R _G				0.7		Ω
SWITCHING CHARACTERISTICS (Note 4)					•		
Turn-On Delay Time	t _{d(ON)}	V_{GS} = 4.5 V, V_{DS} = 15 V, I _D = 1.0 A, R _L = 15 Ω, R _G = 3.0 Ω			20		ns
Rise Time	t _r				20		-
Turn-Off Delay Time	t _{d(OFF)}				30		
Fall Time	t _f				31		
DRAIN-SOURCE DIODE CHARACTERISTI	cs						
Forward Diode Voltage	V _{SD}	V_{GS} = 0 V, I _S = 7.0 A	$T_J = 25^{\circ}C$		0.75	1.0	V
-			T _J = 125°C		0.6		
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, dI _S /dt = 100 A/µs, I _S = 7.0 A			28		ns
Charge Time	t _a				14		1
Discharge Time	t _b				14		
Reverse Recovery Charge	Q _{RR}				23		nC

Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2%.
Switching characteristics are independent of operating junction temperatures.

TYPICAL PERFORMANCE CURVES



TYPICAL PERFORMANCE CURVES



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V_{DS}, DRAIN-TO-SOURCE VOLTAGE (VOLTS) Figure 11. Maximum Rated Forward Biased Safe Operating Area

10

R_{DS(on)} LIMIT THERMAL LIMIT PACKAGE LIMIT

1

0.01 0.1 dc

100

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